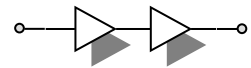


Features

- $S_{21} = 13.0 \text{ dB @ } 3400 \text{ MHz}$
= $11.0 \text{ dB @ } 4200 \text{ MHz}$
- NF of 1.5 dB over Frequency
- Unconditionally Stable
- Single 5V Supply
- High OIP3 @ Low Current

Description

The plerow™ ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.



2-stage Single Type

Specifications (in Production)

Typ. @ $T = 25^{\circ}\text{C}$, $V_s = 5 \text{ V}$, Freq. = 3800 MHz, $Z_{o,sys} = 50 \text{ ohm}$

Parameter	Unit	Specifications		
		Min	Typ	Max
Frequency Range	MHz	3400		4200
Gain	dB	11	12	
Gain Flatness	dB		± 1.0	± 1.1
Noise Figure (NF)	dB		1.5	1.6
Output IP3 ⁽¹⁾	dBm	29	30	
S11 / S22 ⁽²⁾	dB			-11 / -8
Output P1dB	dBm	17	18	
Switching Time ⁽³⁾	μsec		-	
Supply Current	mA		100	120
Supply Voltage	V		5	
Impedance	Ω		50	
Package Type & Size	mm	Surface Mount Type, 10Wx10Lx3.8H		

Operating temperature is -40°C to $+85^{\circ}\text{C}$.

1) OIP3 is measured with two tones at an output power of 4 dBm / tone separated by 1 MHz.

2) S11/S22 (max) is the worst value within the frequency band.

3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V_s .

More Information

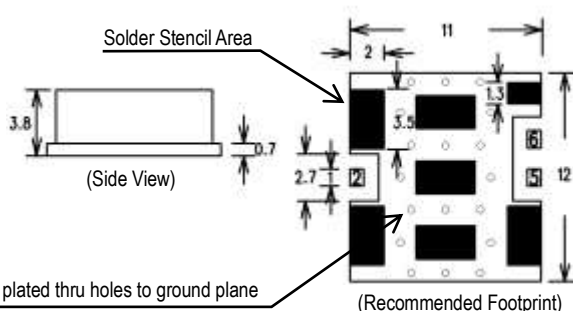
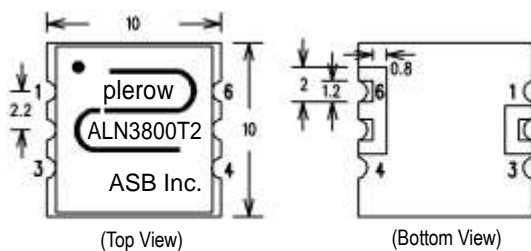
Website: www.asb.co.kr

E-mail: sales@asb.co.kr

Tel: (82) 42-528-7223

Fax: (82) 42-528-7222

Outline Drawing (Unit: mm)



Pin Number	Function
2	RF In
5	RF Out
6	+Vcc
Others	Ground

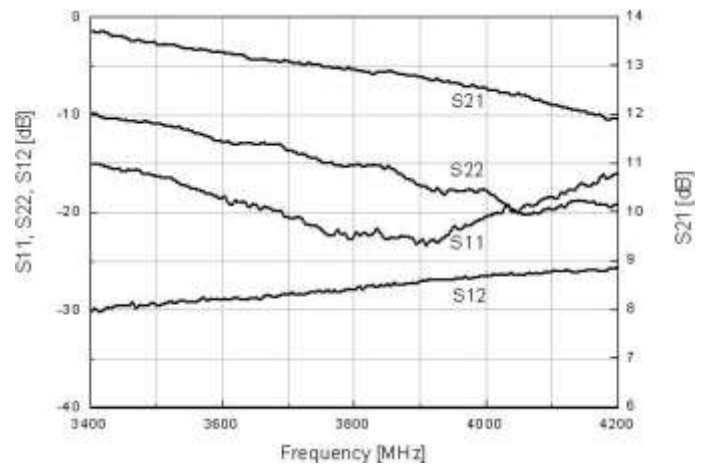
Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.

2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

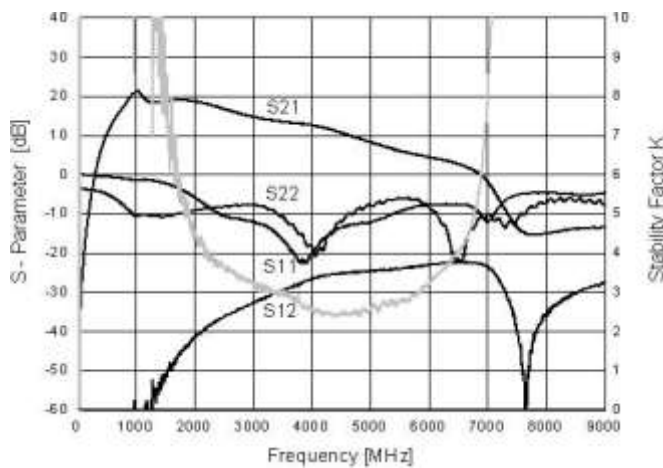
Typical Performance (Measured)

3400~4200 MHz
+5 V

S-parameters

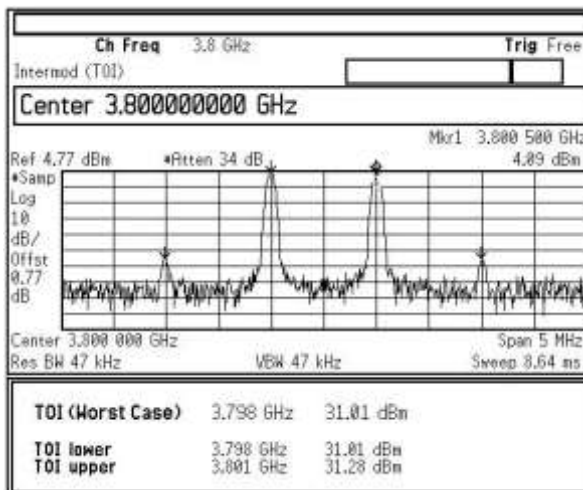


S-parameters & K Factor

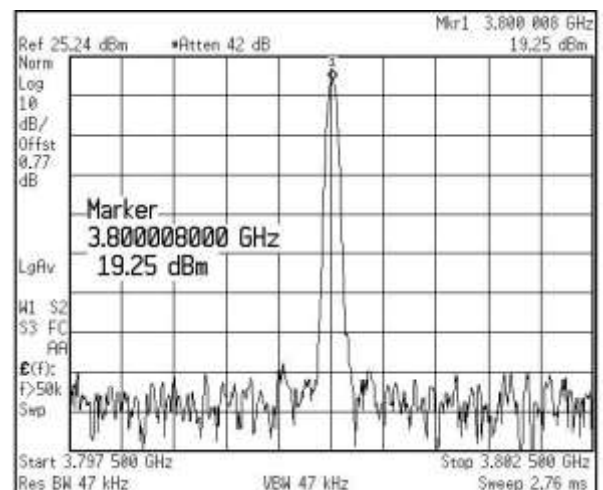


Noise Figure

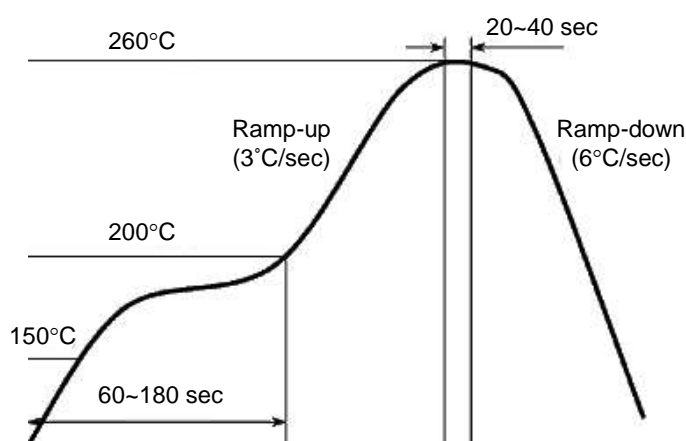
OIP3



P1dB



- ## Recommended Soldering Reflow Process



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